

Name: Mobile phone motherboard glass fixture

Model: BST-189

Material: Aluminum alloy+ glass

Glass thickness: 3mm

Product size: 104*80*20mm

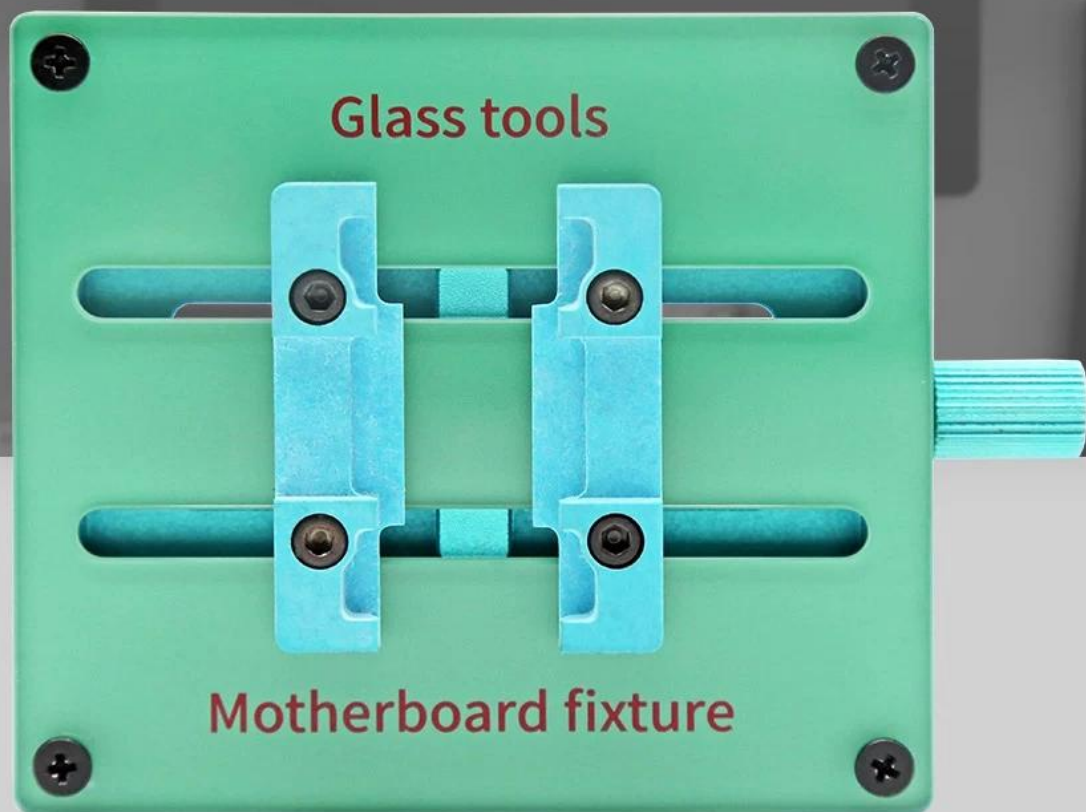
Package size: 112*84*23mm

N.W.: 224g

G.W.: 234g

MOBILE PHONE MOTHERBOARD HEAT INSULATING GLASS FIXTURE

Tempered glass / Corrosion resistance / High temperature resistance



Bidirectional bearings



Heat Insulating Glass



Corrosion resistance



Suitable for multiple motherboards

Specifications



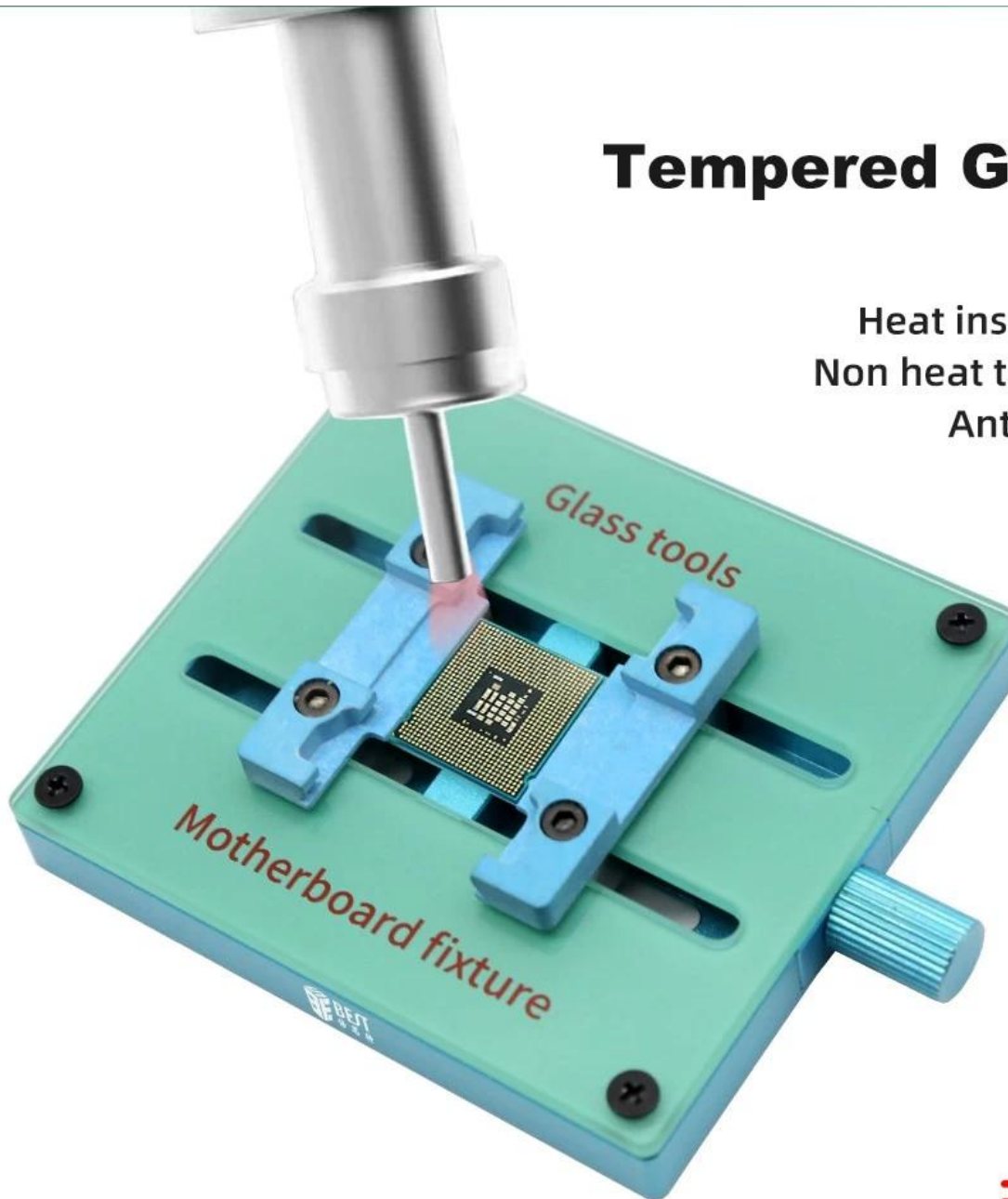
Product Name	Motherboard Glass Fixture
Product Model	BST-189
Material	Aluminum alloy+tempered glass
Glass Thickness	3mm
Base Size	90 * 80 mm
Product Size	104 * 80 * 20mm
Package Size	112 * 84 * 23mm
N. W.	224g
G. W.	234g



Tempered Glass

+

Heat insulation
Non heat transfer
Anti-static

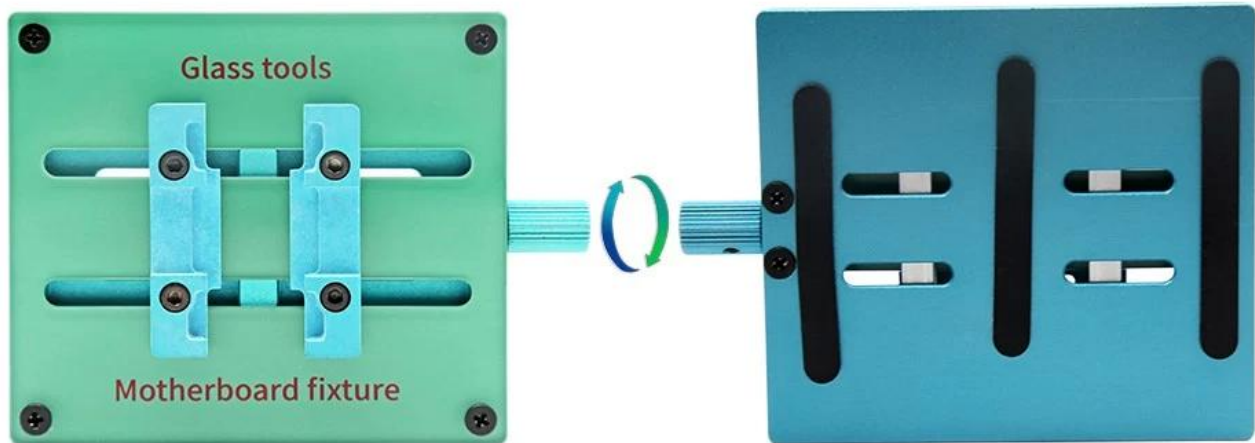


Concealed Screw Arbor



+

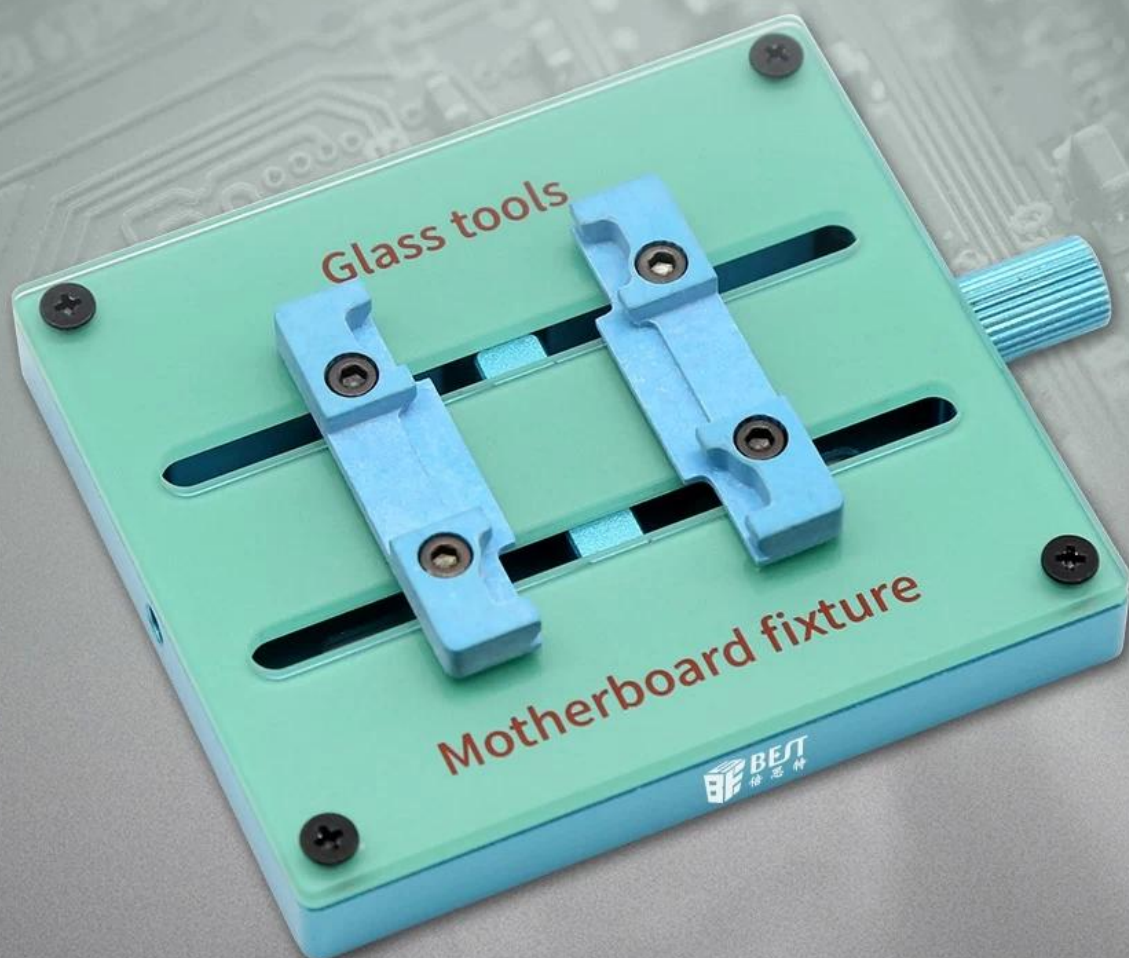
Flexible bidirectional adjustment
More durable and fastening



HEAT INSULATION GLASS

MOTHERBOARD GLASS FIXTURE

BST-189



Product Size

